



# Characterizing Cracking Process in Clayey Soil Using Electrical Resistivity Method

Cheng Zhu<sup>1</sup>, Chao-Sheng Tang<sup>2</sup>, De-Yin Wang<sup>2</sup>

<sup>1</sup>Department of Civil and Environmental Engineering,  
Henry M. Rowan College of Engineering, Rowan University

<sup>2</sup>School of Earth Sciences and Engineering, Nanjing University

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# Introduction

- Desiccation cracking

Sedimentary structures formed as clay-bearing soils dry and contract.



# Introduction

## Mechanical property change

- impaired strength
- excessive deformation
- increased compressibility

## Hydraulic property change

- Increase hydraulic conductivity
- Create preferential pathways for fluids

# Inspection of desiccation cracking

- Visual observation



- Excavation of trenches

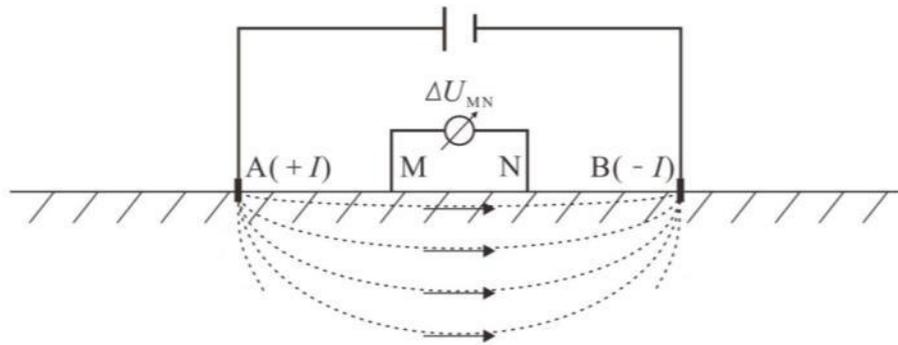


# Electrical resistivity of soil

A sensitive reflection of

- The nature of solid  
(mineralogy, shape, fabric, and size distribution)
- Arrangement of voids  
(porosity, tortuosity, connectivity, pore structure)
- Properties of fluid  
(water content, electrical resistivity, solute concentration)

# Electrical resistivity measurement



Schematic view of electrical resistivity method

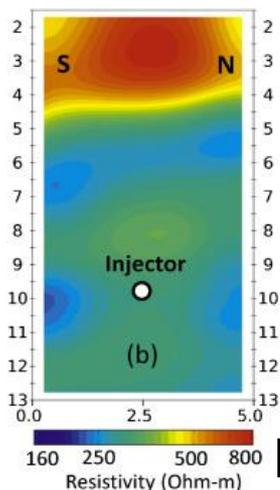


$$\rho = \frac{\Delta U_{MN}}{I} \left( \frac{2\pi}{\frac{1}{MA} - \frac{1}{MB} + \frac{1}{NB} - \frac{1}{NA}} \right) = K \frac{\Delta U_{MN}}{I}$$

- $I$  is the injected current (A)
- $\Delta U_{MN}$  is the measured electrical potential (V) between M and N
- $K$  is a geometrical coefficient
- $MA$ ,  $MB$ ,  $NA$  and  $NB$  represent the relative spacing (m) between electrodes

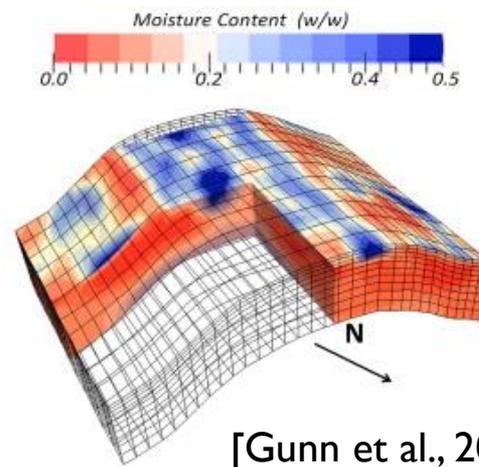
# Applications of electrical resistivity tomography (ERT)

Monitoring CO<sub>2</sub> migration in shallow sand aquifer



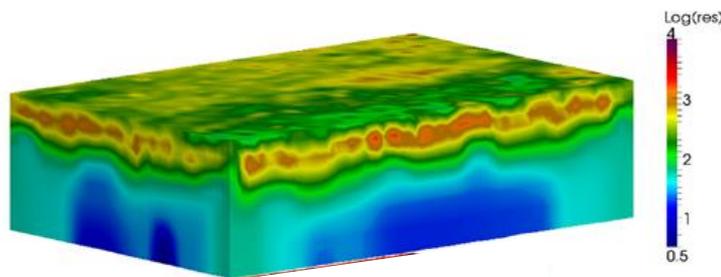
[Yang et al., 2015]

Monitoring moisture change in clay embankments



[Gunn et al., 2015]

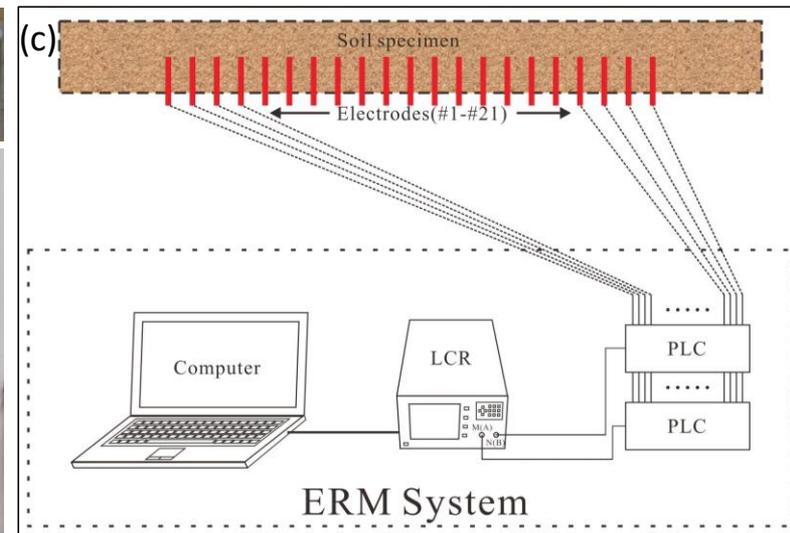
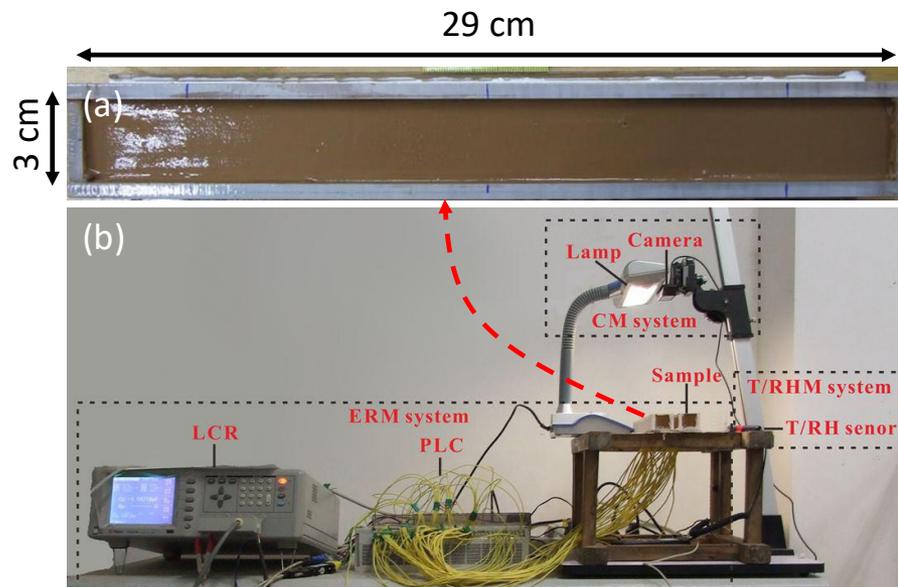
Detecting sand-bedrock interface



[Ward et al., 2014]

# Experimental set up

- Electrical Resistivity Measurement (ERM) system
- Crack Monitoring (CM) system
- Temperature and Relative Humidity (RH) Monitoring (T/RHM) system



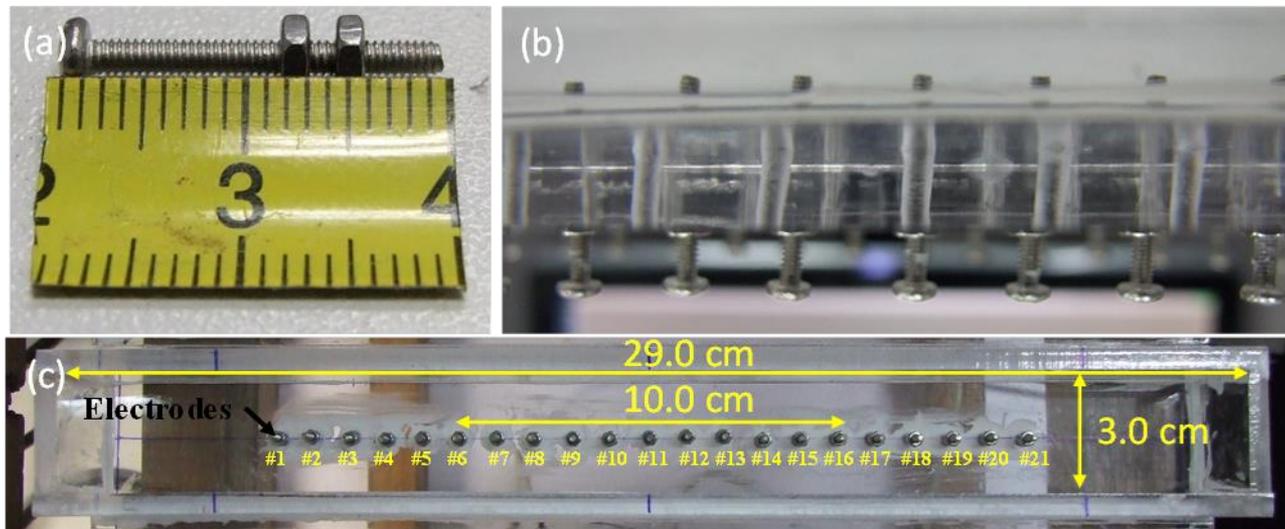
# Soil specimen

- Low plasticity clay (CL)

Soil properties	Value
Specific gravity	2.73
<i>Consistency limit</i>	
Liquid limit (%)	36.5
Plastic limit (%)	19.5
Plasticity index (%)	17.0
USCS classification	CL
<i>Compaction study</i>	
Optimum moisture content (%)	16.5
Maximum dry density (Mg/m <sup>3</sup> )	1.7
<i>Grain size analysis</i>	
Sand (%)	2
Silt (%)	76
Clay (%)	22

# Installation of electrode

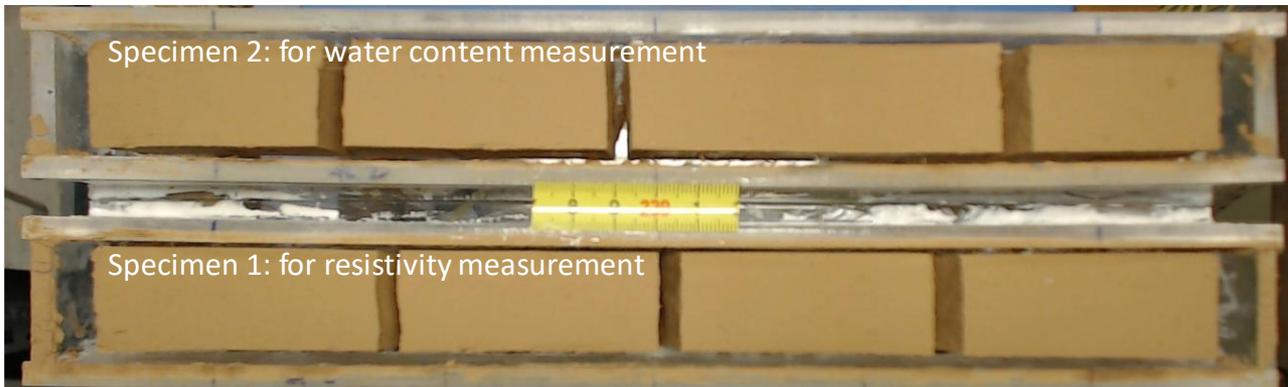
- Twenty-one electrodes were fabricated using stainless steel bolts with a length of 19.0 mm and a diameter of 2.0 mm.



- 3 mm penetration depth: to ensure sufficient soil-electrode interfacial contact.
- The electrode length to electrode spacing ratio is 0.3, a reasonably small value.

# Final crack pattern

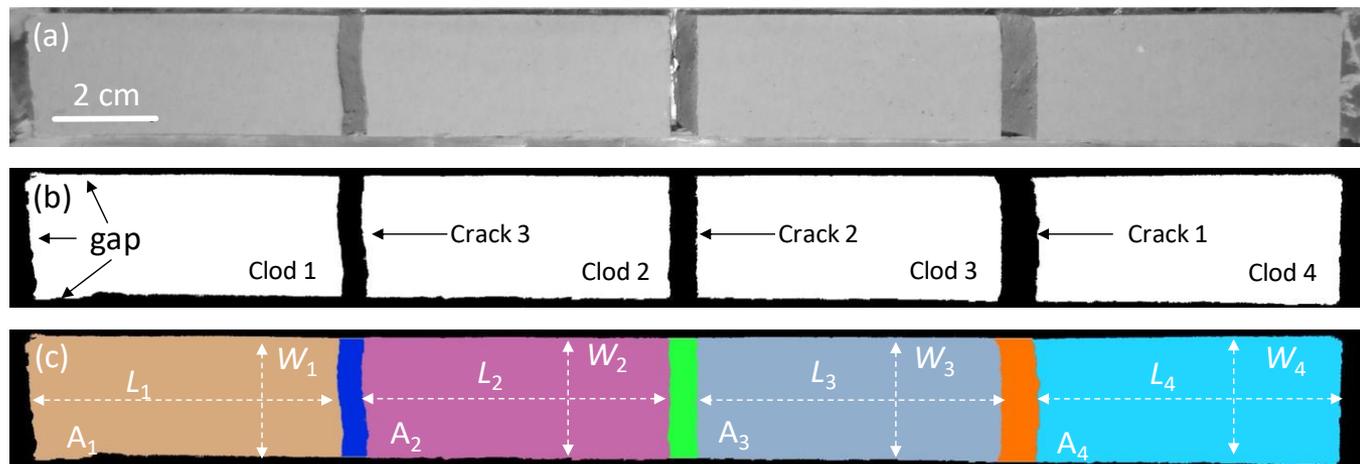
- Specimen 1: electrical resistivity
- Specimen 2: water content measurement



Same crack pattern with similar morphological characteristics

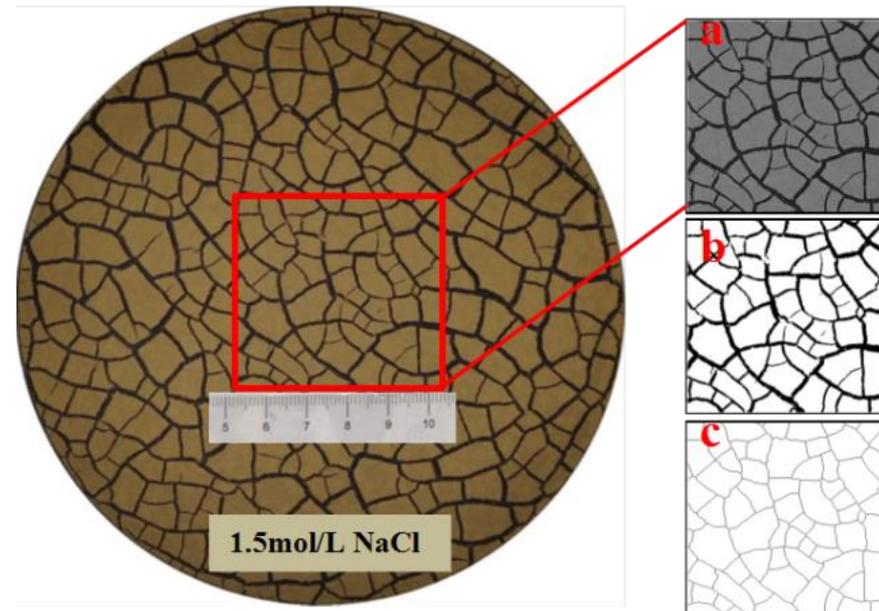
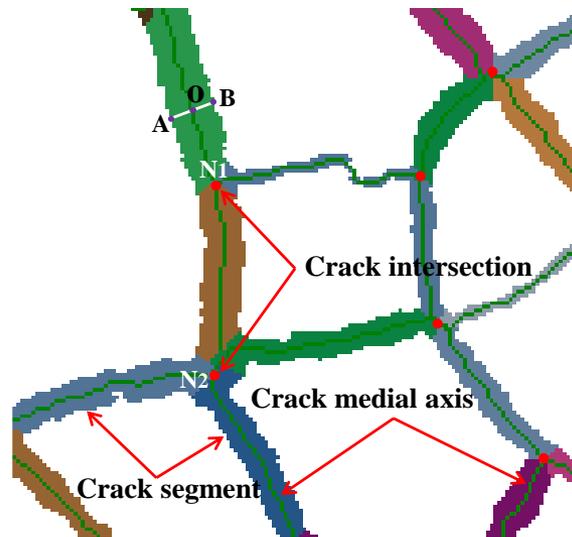
# Image processing procedures

- 1) Convert original image to grey level
- 2) Noise removal through filter and binarization
- 3) Clod and crack recognition and analysis



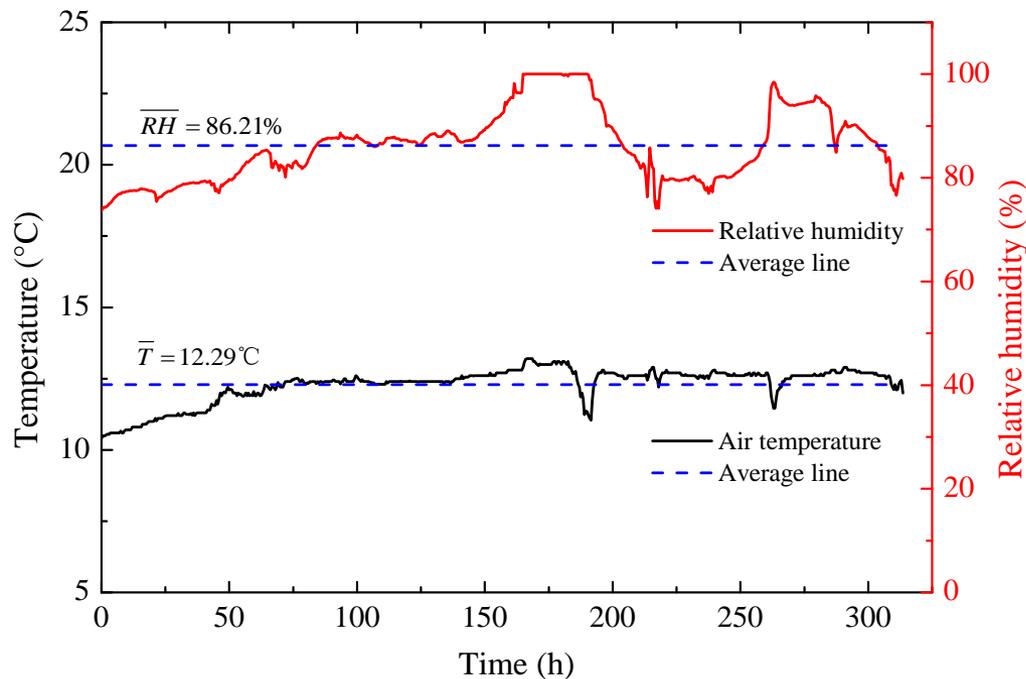
# Crack pattern characterization

- Number of crack segments  $N_{\text{seg}}$
- Number of clods  $N_c$
- Average width of cracks  $W_{\text{av}}$
- Average area of clods  $A_{\text{av}}$
- Longitudinal shrinkage strain  $e_{\text{Lon}}$
- Lateral shrinkage strain  $e_{\text{Lat}}$
- Surface shrinkage strain  $e_{\text{Sur}}$



# Laboratory T & RH conditions

- The time histories of temperature and relative humidity exhibit minor fluctuations.

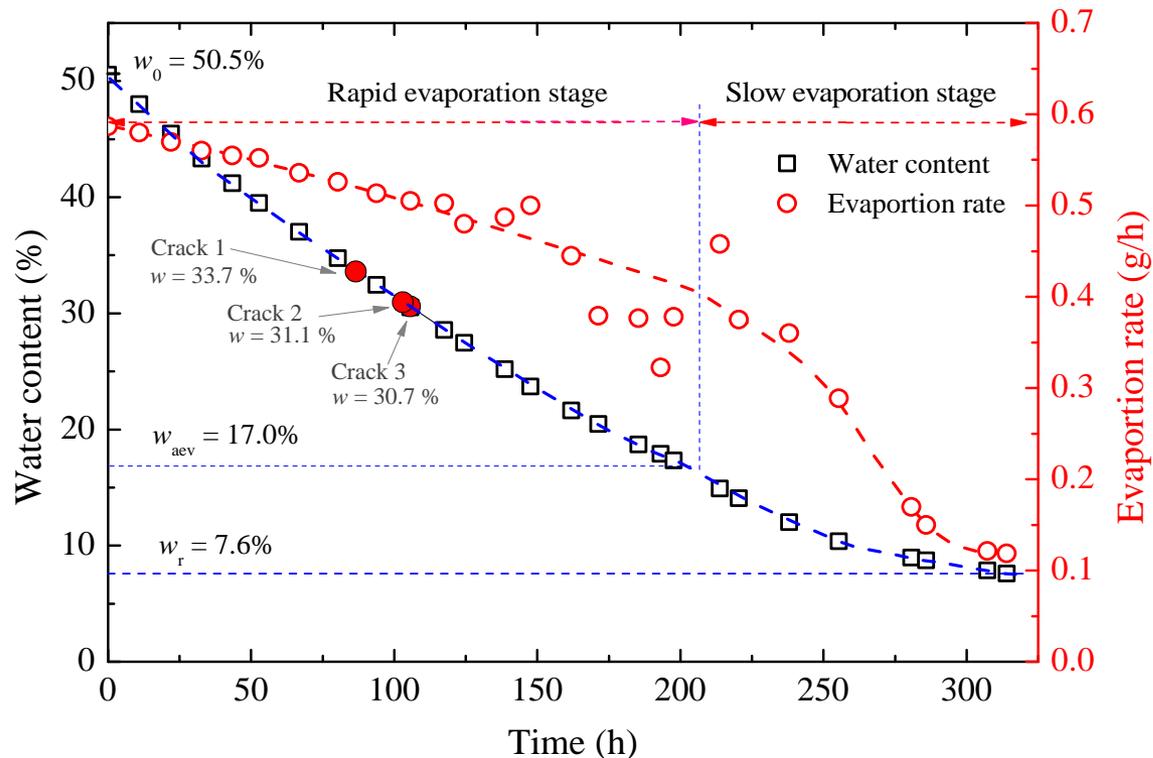


relative humidity varying  
within  $86.21 \pm 13.8\%$

temperature varying  
within  $12.29 \pm 1.85\text{ }^\circ\text{C}$

# Water evaporation

- Water content decreases with drying time.
- Evaporation rate decreases with drying time.



Temporal variations of water content and evaporation rate

# Desiccation cracking process



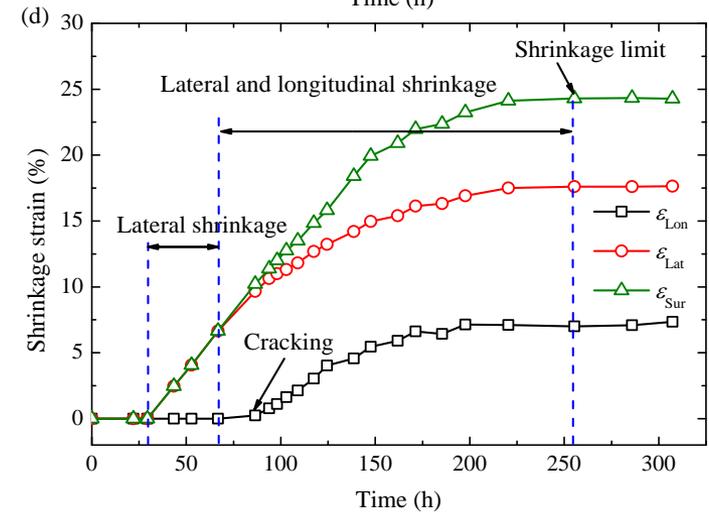
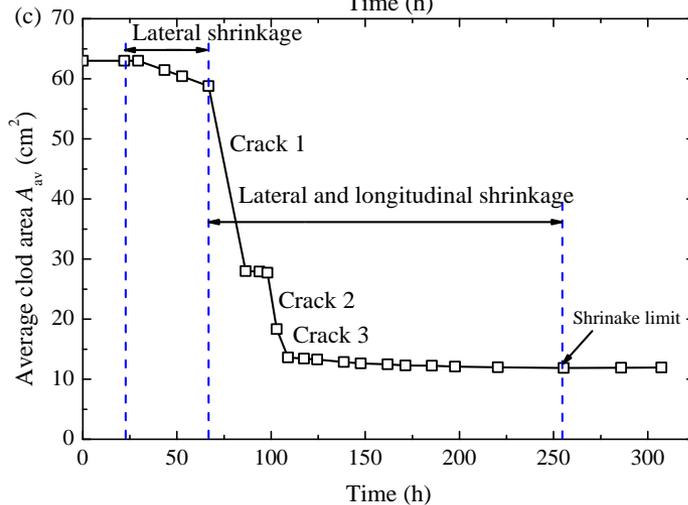
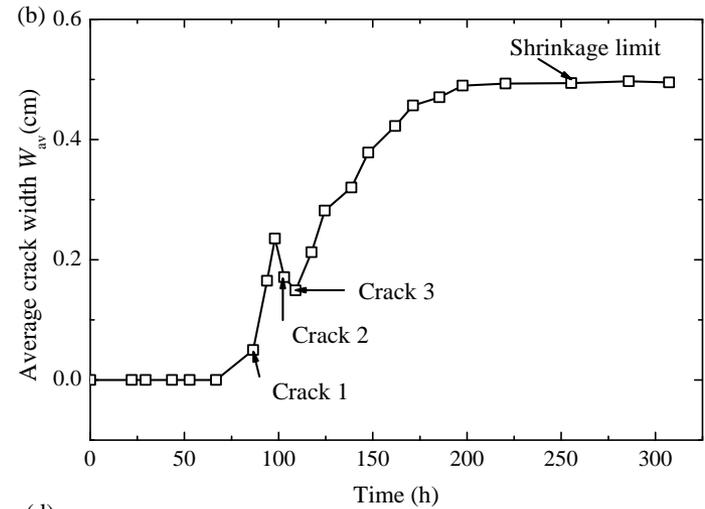
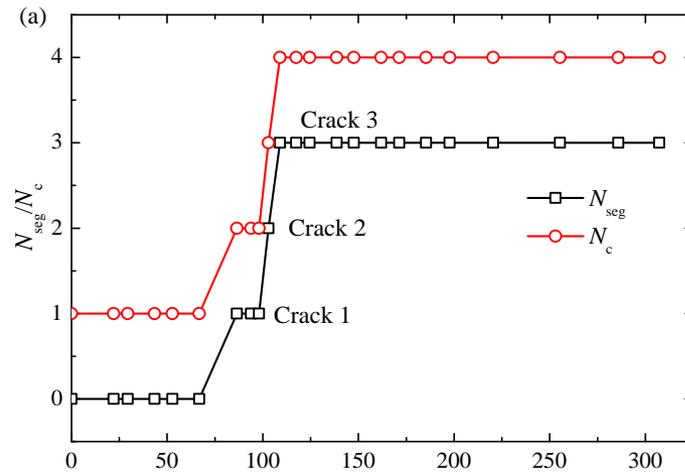
A total of three cracks were formed nearly parallel to each other and perpendicular to the longitudinal direction of the specimen.

Crack 1: formed at 86.5 h

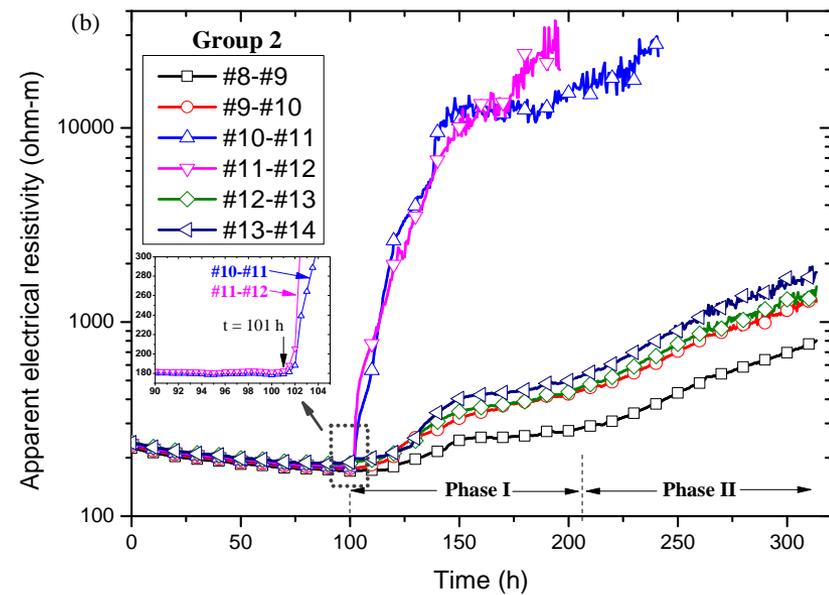
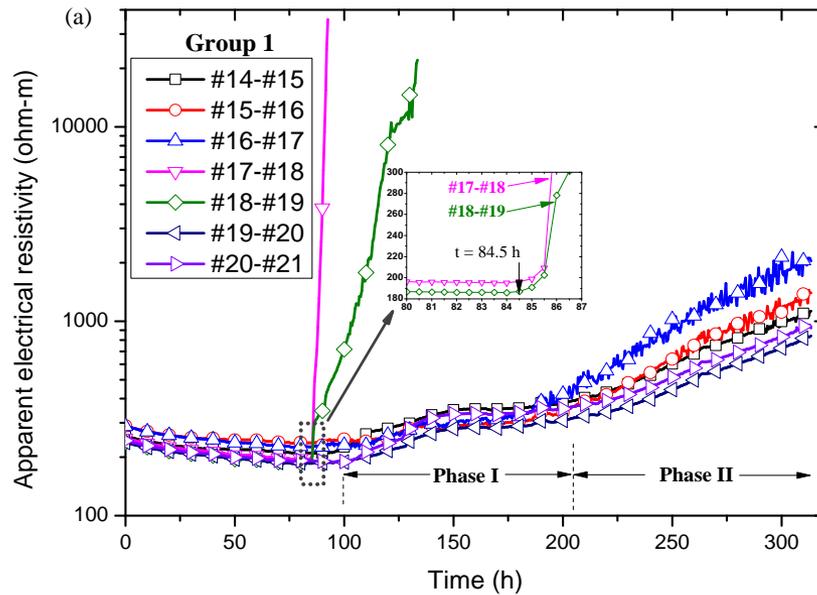
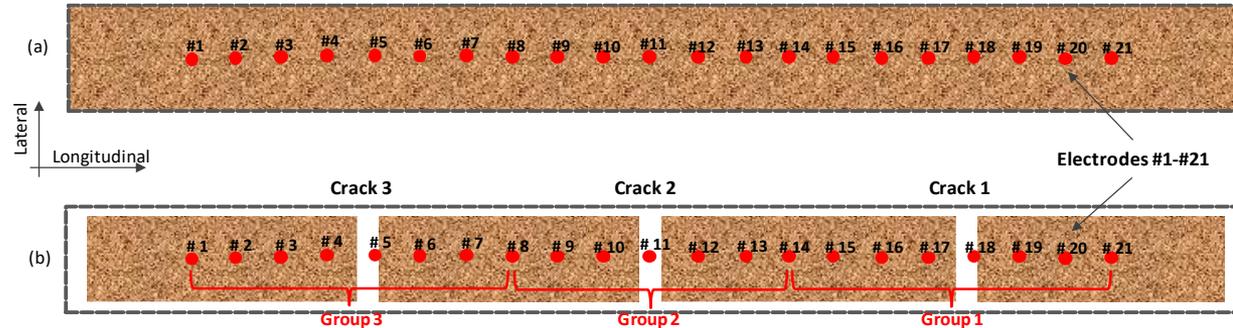
Crack 2: formed at 102.8 h

Crack 3: formed at 103.0 h

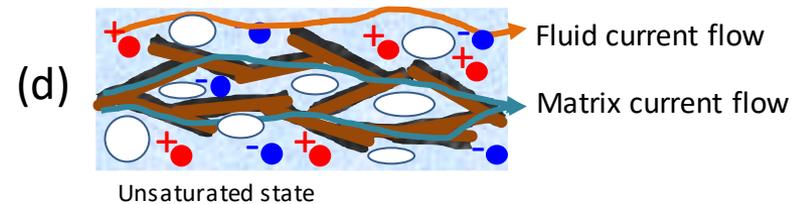
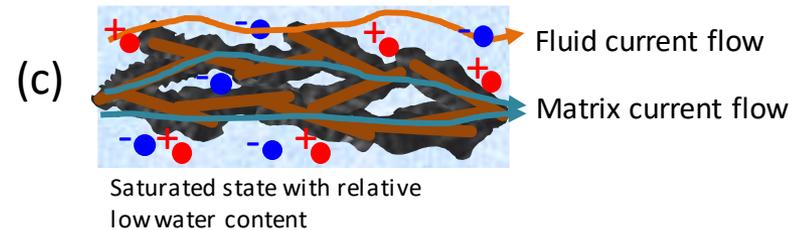
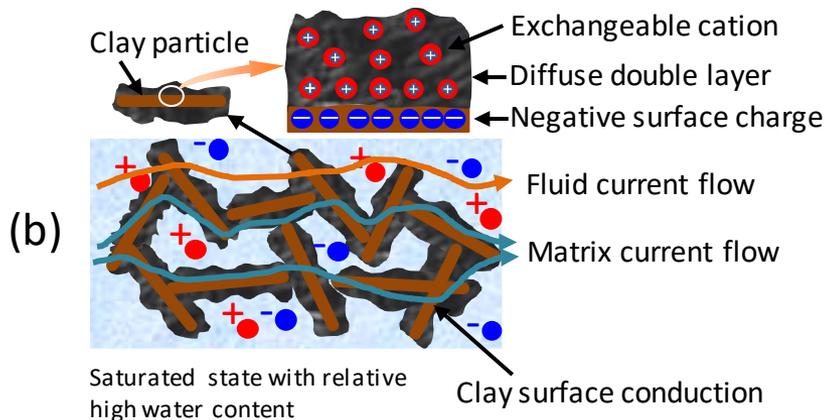
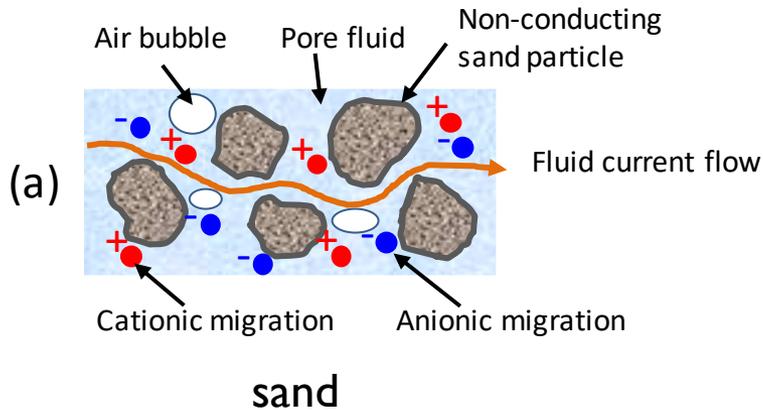
# Geometrical parameters of crack patterns



# Temporal variation of $\rho$

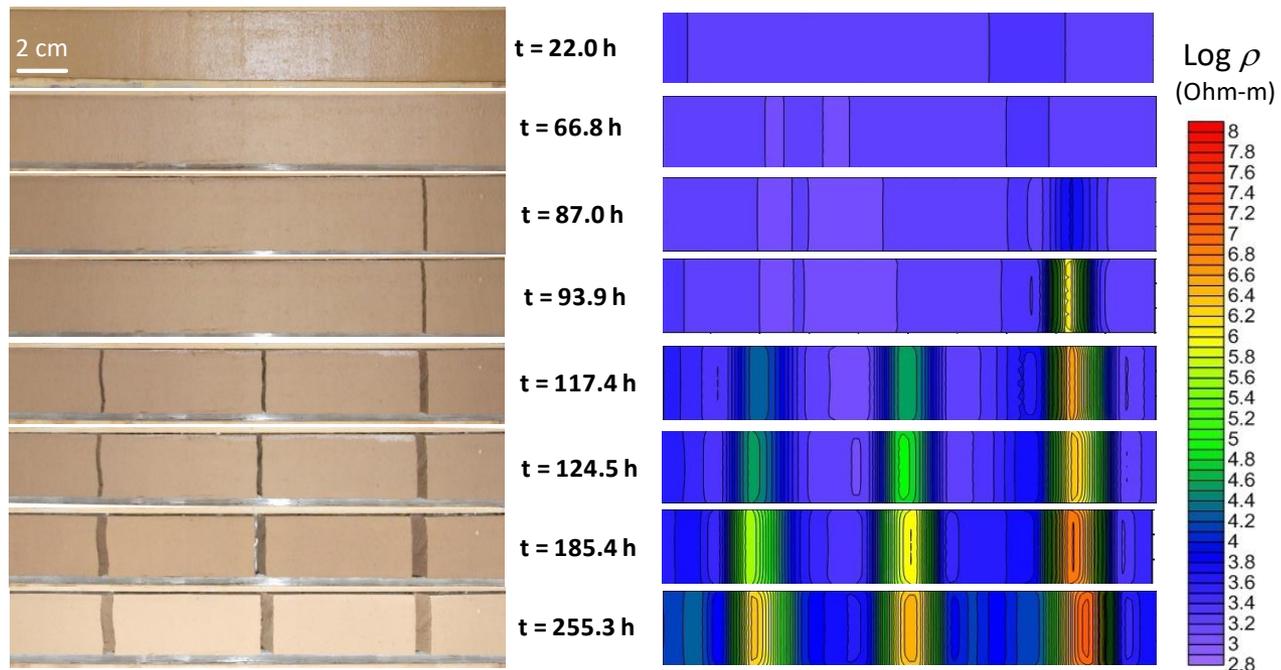


# Electrical conduction behavior of different soils



# Electrical resistivity tomography

- Crack initiation and growth
- Crack pattern (location, width, geometry)



Crack patterns

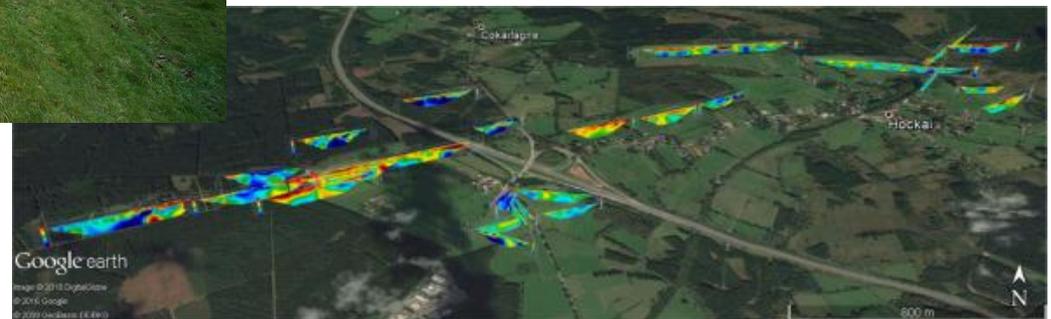
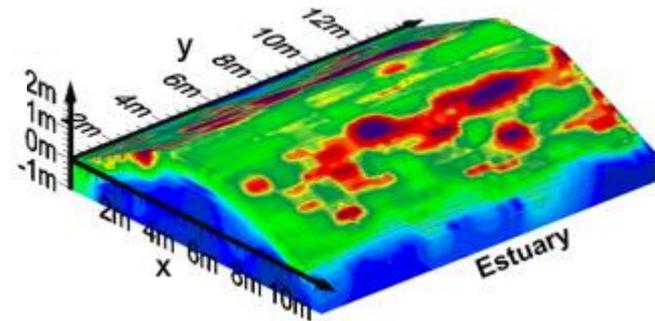
Apparent resistivity images

# Conclusions

- Water evaporation is governed by the temperature and relative humidity at the soil-air interface.
- The volumetric shrinkage of the specimen shows evident anisotropic characteristics.
- The evolution of electrical resistivity in clay is dominated by two competing effects: (1) closer packing of soil fabric and higher concentration of ions in pore fluids, and (2) the evaporation-induced water loss associated with hydration film contraction and desiccation crack insulation.
- ERT is reliable to map the potential cracks' positions.

# Future study

- Future works will be carried out to improve our fundamental understanding of the correlations between physical and electrical properties of soil in a higher dimensional space at larger scale during the desiccation cracking process.





# Thank you!

Contact: [zhuc@rowan.edu](mailto:zhuc@rowan.edu)